8-input multiplexer

Rev. 3 — 26 January 2015

Product data sheet

1. General description

The 74HC151-Q100; 74HCT151-Q100 are 8-bit multiplexer with eight binary inputs (I0 to I7), three select inputs (S0 to S2) and an enable input (\overline{E}). One of the eight binary inputs is selected by the select inputs and routed to the complementary outputs (Y and \overline{Y}). A HIGH on \overline{E} forces the output Y LOW and output \overline{Y} HIGH. Inputs also include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Specified in compliance with JEDEC standard no. 7A
- Input levels:
 - For 74HC151-Q100: CMOS level
 - For 74HCT151-Q100: TTL level
- Low-power dissipation
- Non-inverting data path
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

3. Ordering information

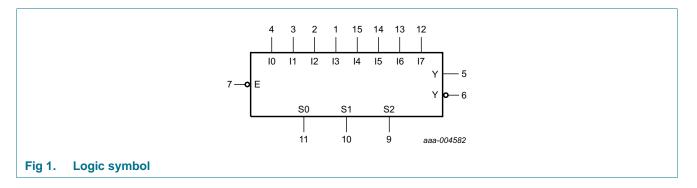
Table 1.Ordering information

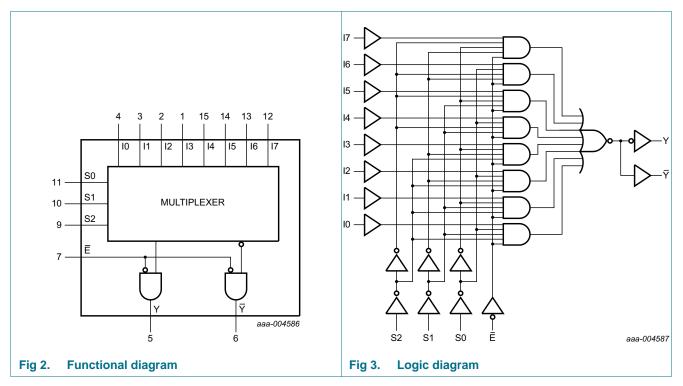
Type number	Package	ckage								
	Temperature range	Name	Description	Version						
74HC151D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width	SOT109-1						
74HCT151D-Q100			3.9 mm							
74HC151PW-Q100	–40 °C to +125 °C	TSSOP16	Free							
74HCT151PW-Q100			body width 4.4 mm							



8-input multiplexer

4. Functional diagram

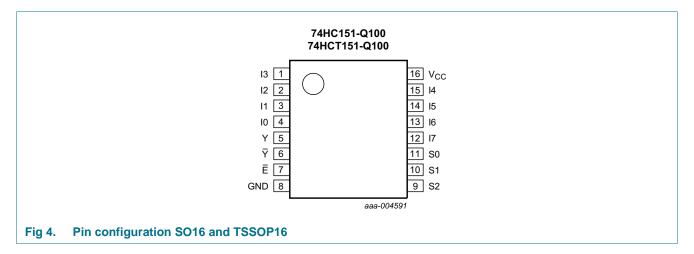




8-input multiplexer

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
10 to 17	4, 3, 2, 1, 15, 14, 13, 12	data inputs
Y	5	multiplexer output
Y	6	complementary multiplexer output
Ē	7	enable input (active LOW)
GND	8	ground (0 V)
S0, S1, S2	11, 10, 9	common data select inputs
V _{CC}	16	supply voltage

8-input multiplexer

6. Functional description

Table 3. Function table^[1]

Input	:											Output	
E	S2	S1	S0	10	I 1	12	13	14	15	I 6	17	Y	Y
Н	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	L	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	Н	Х	Х	Х	Х	Х	Х	Х	L	Н
L	L	L	Н	Х	L	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	Н	Х	Н	Х	Х	Х	Х	Х	Х	L	Н
L	L	Н	L	Х	Х	L	Х	Х	Х	Х	Х	Н	L
L	L	Н	L	Х	Х	Н	Х	Х	Х	Х	Х	L	Н
L	L	Н	Н	Х	Х	Х	L	Х	Х	Х	Х	Н	L
L	L	Н	Н	Х	Х	Х	н	Х	Х	Х	Х	L	Н
L	Н	L	L	Х	Х	Х	Х	L	Х	Х	Х	Н	L
L	Н	L	L	Х	Х	Х	Х	Н	Х	Х	Х	L	Н
L	Н	L	Н	Х	Х	Х	Х	Х	L	Х	Х	Н	L
L	Н	L	Н	Х	Х	Х	Х	Х	Н	Х	Х	L	Н
L	Н	Н	L	Х	Х	Х	Х	Х	Х	L	Х	Н	L
L	Н	Н	L	Х	Х	Х	Х	Х	Х	Н	Х	L	Н
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	L	Н	L
L	н	Н	Н	Х	Х	Х	Х	Х	Х	Х	Н	L	Н

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _O	output current	$V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-	-50	mA
T _{stg}	storage temperature		-65	+150	°C

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
	SO16 package	[1]	-	500	mW
	TSSOP16 package	[2]	-	500	mW

[1] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

[2] For TSSOP16 package: Ptot derates linearly with 5.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74	IC151-Q	100	74H	CT151-0	100	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

8-input multiplexer

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{ar}	_{nb} = 25	°C		40 °C to 5 °C		-40 °C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC15	1-Q100									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
	V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V	
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current		-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-					pF

8-input multiplexer

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{ai}	_{nb} = 25	°C		40 °C to 5 °C		-40 °C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT1	51-Q100	1								
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
VIL	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -4 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current		-	-	8.0	-	80	-	160	μA
Δl _{CC}	additional supply current	$\label{eq:VI} \begin{array}{l} V_I = V_{CC} - 2.1 \text{ V};\\ \text{other inputs at } V_{CC} \text{ or GND};\\ V_{CC} = 4.5 \text{ V to 5.5 V};\\ I_O = 0 \text{ A} \end{array}$								
		per input pin; In inputs	-	45	162	-	203	-	221	μA
		per input pin; E input	-	30	108	-	135	-	147	μA
		per input pin; Sn input	-	150	540	-	675	-	735	μA
CI	input capacitance		-	3.5	-					pF

8-input multiplexer

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 7.

Symbol	Parameter	Conditions		T _{an}	_{nb} = 25	°C		= –40 °C 85 °C	T _{amb} = −40 °C to +125 °C		Unit
			-	Min	Тур	Max	Min	Max	Min	Max	_
74HC15	1-Q100				1			1			
t _{pd}	propagation	In to Y; see Figure 5	[1]								
	delay	V _{CC} = 2.0 V		-	52	170	-	215	-	255	ns
		V _{CC} = 4.5 V		-	19	34	-	43	-	51	ns
		V _{CC} = 5 V; C _L = 15 pF		-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	15	29	-	37	-	43	ns
		In to \overline{Y} ; see Figure 5	[1]								
		V _{CC} = 2.0 V		-	58	185	-	230	-	280	ns
		V _{CC} = 4.5 V		-	21	37	-	46	-	56	ns
		V _{CC} = 5 V; C _L = 15 pF		-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	17	31	-	39	-	48	ns
		Sn to Y; see Figure 6	[1]								
		V _{CC} = 2.0 V		-	61	185	-	230	-	280	ns
		V _{CC} = 4.5 V		-	22	37	-	46	-	56	ns
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	18	31	-	39	-	48	ns
		Sn to \overline{Y} ; see Figure 6	<u>[1]</u>								
		V _{CC} = 2.0 V		-	61	205	-	255	-	310	ns
		V _{CC} = 4.5 V		-	22	41	-	51	-	62	ns
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	18	35	-	43	-	53	ns
		E to Y; see Figure 6									
		V _{CC} = 2.0 V		-	41	125	-	155	-	190	ns
		V _{CC} = 4.5 V		-	15	25	-	31	-	38	ns
		V _{CC} = 5 V; C _L = 15 pF		-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	12	21	-	26	-	32	ns
		E to Y; see Figure 6									
		V _{CC} = 2.0 V		-	47	145	-	180	-	220	ns
		V _{CC} = 4.5 V		-	17	29	-	36	-	44	ns
		V _{CC} = 5 V; C _L = 15 pF		-	14	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	14	25	-	31	-	38	ns
t _t	transition	Y, Y; see Figure 5	[2]								
	time	V _{CC} = 2.0 V		-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V		-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$		-	6	13	-	16	-	19	ns

8-input multiplexer

Symbol	Parameter	Conditions		Tan	_{nb} = 25	°C		= –40 °C 85 °C		: –40 °C I25 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	_
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	[3]	-	40	-	-	-	-	-	pF
74HCT1	51-Q100										
t _{pd}	propagation	In to Y; see Figure 5	[1]								
delay	V _{CC} = 4.5 V		-	22	38	-	48	-	57	ns	
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
		In to \overline{Y} ; see Figure 5	[1]								
		V _{CC} = 4.5 V		-	22	38	-	48	-	57	ns
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
		Sn to Y; see Figure 6	[1]								
		V _{CC} = 4.5 V		-	23	41	-	51	-	62	ns
		V _{CC} = 5 V; C _L = 15 pF		-	20	-	-	-	-	-	ns
		Sn to \overline{Y} ; see Figure 6	[1]								
		V _{CC} = 4.5 V		-	25	43	-	54	-	65	ns
		V _{CC} = 5 V; C _L = 15 pF		-	20	-	-	-	-	-	ns
		E to Y; see Figure 6	[1]								
		V _{CC} = 4.5 V		-	16	29	-	36	-	44	ns
		V _{CC} = 5 V; C _L = 15 pF		-	13	-	-	-	-	-	ns
		\overline{E} to \overline{Y} ; see Figure 6	[1]								
		$V_{CC} = 4.5 V$		-	21	36	-	45	-	54	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	18	-	-	-	-	-	ns
t _t	transition	Y, \overline{Y} ; see Figure 5	[2]								
	time	V _{CC} = 4.5 V		-	7	15	-	19	-	22	ns
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ V _I = GND to V _{CC} - 1.5 V	[3]	-	40	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 7.

 $\label{eq:tpd} [1] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

 $\begin{array}{ll} \mbox{[3]} & C_{PD} \mbox{ is used to determine the dynamic power dissipation (P_D in μW).} \\ & P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \mbox{ where:} \end{array}$

 $f_i = input frequency in MHz;$

 $f_o = output$ frequency in MHz;

 C_L = output load capacitance in pF;

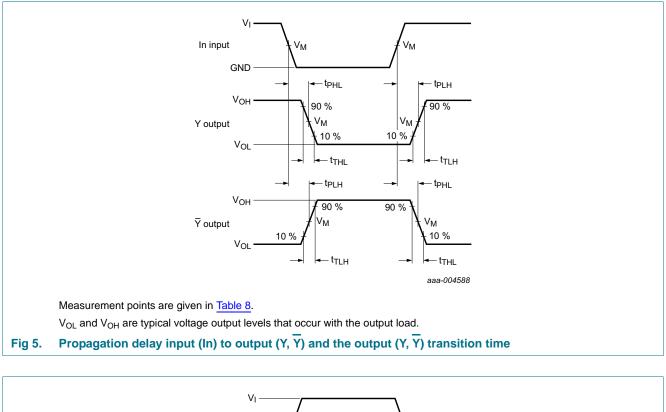
V_{CC} = supply voltage in V;

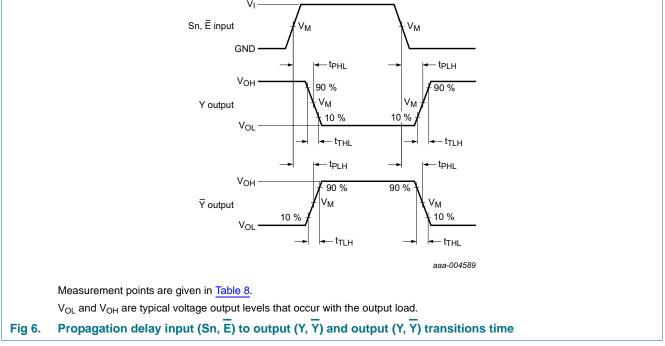
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

8-input multiplexer

11. Waveforms





74HC_HCT151_Q100

All information provided in this document is subject to legal disclaimers.

10 of 17

8-input multiplexer

Table 8. **Measurement points**

Туре	Input	Output
	V _M	V _M
74HC151-Q100	0.5V _{CC}	0.5V _{CC}
74HCT151-Q100	1.3 V	1.3 V

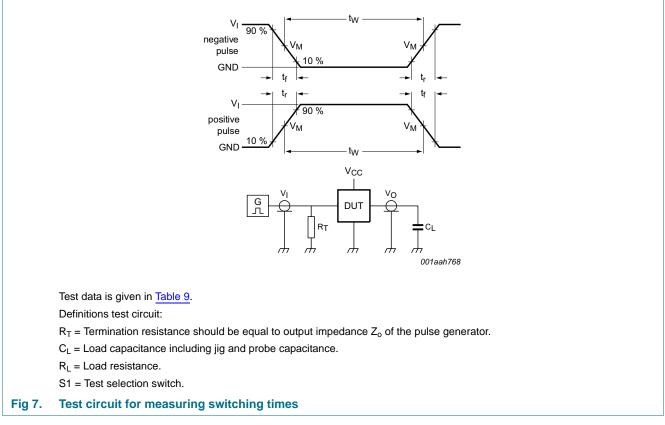


Table 9. Test data									
Туре	Input		Load	Test					
	VI	t _r , t _f	CL						
74HC151-Q100	V _{CC}	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}					
74HCT151-Q100	3.0 V	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}					

8-input multiplexer

12. Package outline

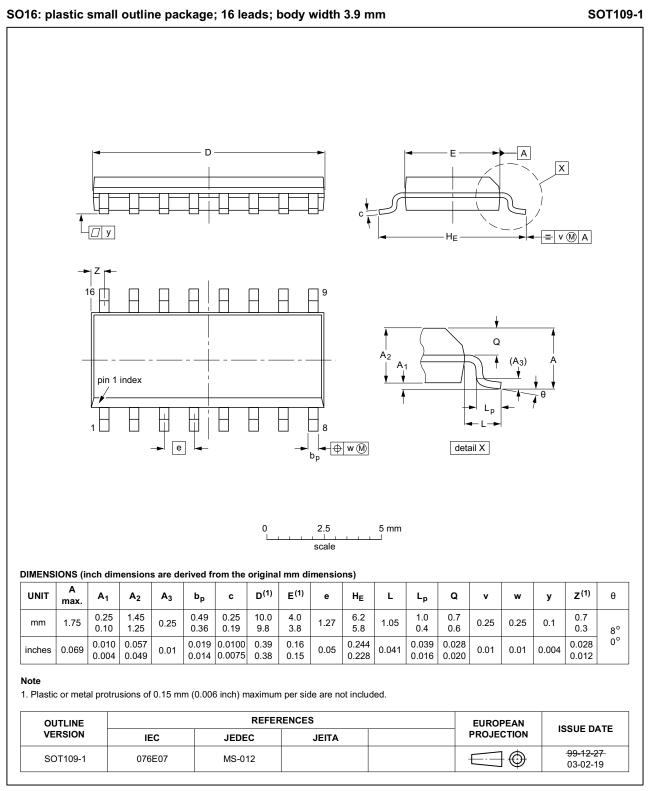


Fig 8. Package outline SOT109-1 (SO16)

All information provided in this document is subject to legal disclaimers.

8-input multiplexer

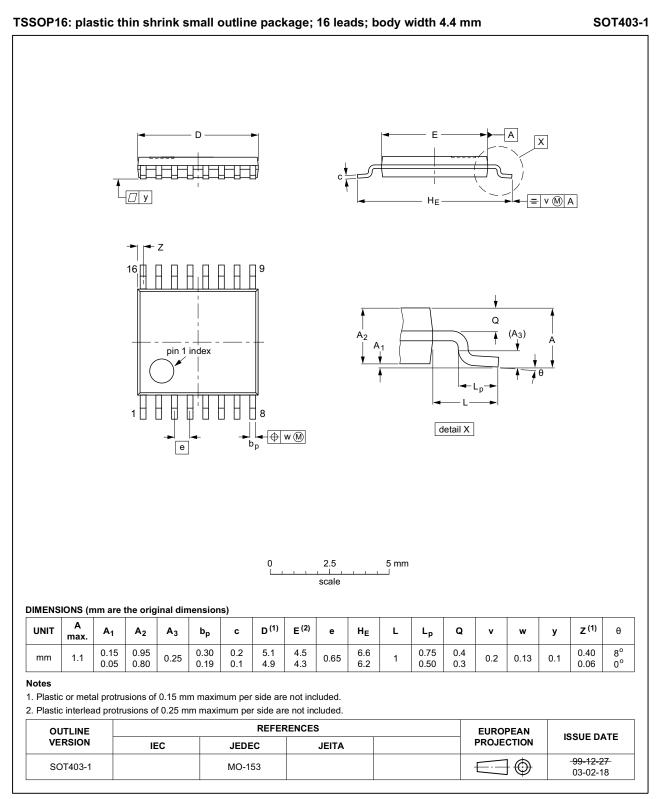


Fig 9.Package outline SOT403-1 (TSSOP16)

All information provided in this document is subject to legal disclaimers.

8-input multiplexer

13. Abbreviations

Table 10. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		
MIL	Military		

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT151_Q100 v.3	20150126	Product data sheet	-	74HC_HCT151_Q100 v.2
Modifications:	• <u>Table 7</u> : Power dissipation capacitance condition for 74HCT151-Q100 is corrected.			
74HC_HCT151_Q100 v.2	20130211	Product data sheet	-	74HC_HCT151_Q100 v.1
Modifications:	New descriptive title (errata).			
74HC_HCT151_Q100 v.1	20120807	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications - This NXP

Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

8-input multiplexer

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning 3
5.2	Pin description 3
6	Functional description 4
7	Limiting values 4
8	Recommended operating conditions 5
9	Static characteristics 6
10	Dynamic characteristics 8
11	Waveforms 10
12	Package outline 12
13	Abbreviations 14
14	Revision history 14
15	Legal information 15
15.1	Data sheet status 15
15.2	Definitions 15
15.3	Disclaimers
15.4	Trademarks 16
16	Contact information 16
17	Contents 17

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP Semiconductors N.V. 2015.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 26 January 2015 Document identifier: 74HC_HCT151_Q100